



In re Application of: FUMIAKI AGA
 Application No. 09/838,161
 Filed: April 20, 2001
 For: EPOXY RESIN ENCAPSULATING SEMICONDUCTOR CHIP AND MARKED RESIN ENCAPSULATED SEMICONDUCTOR CHIP

COMMISSIONER FOR PATENTS
 Washington, D.C. 20231

Sir:

Transmitted herewith is a response to an office action in the subject application.

Applicants claim small entity status of this application under 37 CFR 1.27.

Petition for Extension of Time

- Applicants petition for a one-month extension of time under 37 CFR 1.136, the fee for which is \$110.00 (enclosed).
- Applicants believe that no petition for an extension of time is necessary. However, to the extent that such petition is deemed necessary, Applicants hereby petition for a sufficient extension of time to render the present submission timely. Please charge Deposit Account No. 12-1216 for the appropriate petition fee.

No additional claim fee is required.

Other: Partial English translation of Japanese Patent Laid-Open No. 10-204155.

The claim fee has been calculated as shown below:

					SMALL ENTITY		OTHER THAN A SMALL ENTITY	
CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	EXTRA CLAIMS PRESENT	RATE	ADDT. CLAIM FEE	RATE	ADDT. CLAIM FEE	
TOTAL		MINUS	=	x 9=	\$	x 18=	\$	
INDEPENDENT		MINUS	=	x 42=	\$	x 84=	\$	
<input type="checkbox"/> FIRST PRESENTATION OF MULTIPLE CLAIM				+ 140=	\$	+ 280=	\$	
				TOTAL	\$	TOTAL	\$	

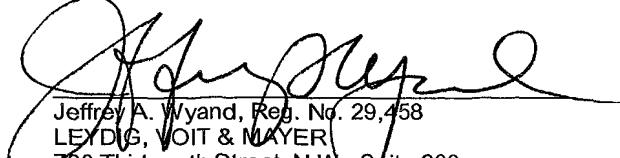
Please charge my Deposit Account No. 12-1216 in the amount of \$110.00. A duplicate copy of this sheet is attached.

A check in the amount of \$ is attached.

The Commissioner is hereby authorized to charge any deficiencies in the following fees associated with this communication or credit any overpayment to Deposit Account No. 12-1216. A duplicate copy of this sheet is attached.

- Any filing fees under 37 CFR 1.16 for the presentation of extra claims.
- Any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,


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Date: October 3, 2002
 JAW:ves

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PATENT
Attorney Docket No. 401171/Fukami

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

FUMIAKI AGA

Application No. 09/838,161

Art Unit: 2827

Filed: April 20, 2001

Examiner: L. Cruz

For: EPOXY RESIN ENCAPSULATING
SEMICONDUCTOR CHIP AND
MARKED RESIN ENCAPSULATED
SEMICONDUCTOR CHIP

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RESPONSE TO OFFICE ACTION

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Office Action dated June 7, 2002, please enter the following amendments and consider the following remarks.

AMENDMENTS

IN THE CLAIMS:

Cancel claims 1, 5, and 7 and replace the indicated claims with:

3. (Twice Amended) The semiconductor device according to claim 6, wherein a color difference between color of a laser mark on a surface of said package and color of the surface of said package where the laser mark is not present, as measured by a colorimeter, has a value of at least 10.

4. (Amended) The semiconductor device according to claim 6, wherein said package includes a dye providing the color of the surface of said package.